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CNTD (Controlled Nucleation Thermochemical Deposition) Methyltrichlorosilane Gas Pre-heat Temperature

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Precursor Polymer

20. ABSTRACT (Continue on reverse side if necessary and identify by block number)

Presented herein are results of research conducted at Chemetal Corp. under Cont. No. F49620-77-C-0086 during the period from April 1977 to December 1978. The purpose of this research was to investigate the CNTD (Controlled Nucleation Thermochemical Deposition) process developed at Chemetal as it applies to the microstructural properties of silicon carbide. A general parametric study was conducted of the silicon carbide chemical vapor deposition system with emphasis on parameters which might influence directly the mechanism of CNTD. An iterative approach was employed which related deposition conditions to room temperature

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tensile strength and microstructure. It was hypothesized that conditions which effected minimum grain size with a probable minimum flaw population in deposits would result in increased strength.

CNTD silicon carbide deposits with average grain sizes of $500-1000\text{\AA}$ were obtained. Room temperature flexural strengths in excess of 3000 MPa (435 kpsi) were recorded on wire samples. Strength was found to be strongly dependent upon microstructure and probably on composition of the deposit.

Unexpectedly high fracture toughnesses were observed (15 to 16 MPa in some samples) and were associated with the presence of chlorine during preliminary studies. Widely varying strengths were observed in furnace deposited bend bar samples indicating that the deposition conditions for CNTD SiC on directly heated wire substrates require significant changes when deposition is done in a hot wall furnace.

Written by

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Technical Information Officer

AN INVESTIGATION OF THE CNTD MECHANISM AND ITS EFFECT ON MICROSTRUCTURAL PROPERTIES

CONTRACT NUMBER F49620-77-0086

CHEMETAL NUMBER 4208

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FINAL TECHNICAL REPORT

17 March 1977 - 15 December 1978

THE AIR FORCE OFFICE OF SCIENTIFIC RESEARCH

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FORWARD

This Final Technical Report, covering the period from 15 March 1977 to 15 December 1978 was prepared by Chemetal Corporation under Air Force Office of Scientific Research Contract F49620-77-C-0086. Major Wilbur C. Simmons is the Program Monitor.

The Principal Investigator is Mr. Robert A. Holzl. The Program Managers were Dr. Jacob J. Stiglich and Mr. Brian G. Zealear. Experimentation and evaluation was conducted by Messrs. Ben H. Tilley, Sam H. Rustomji, and Deepak Bhat.

The research is being coordinated with other government agencies. Joint investigations have been made with and data shared with the following:

Air Force Materials Laboratory, Dr. Henry Graham NASA-Lewis Research Center, Dr. Sumil Dutta Naval Research Laboratory, Dr. R. W. Rice

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I. INTRODUCTION

INTRODUCTION

Silicon carbide has been the object of much research and development attention in recent years because of its potential as a structural material to be used in high temperature, erosive, corrosive environments such as gas turbine engines. Chemical Vapor Deposition (CVD) silicon carbide is thought to have potential because it is made without additives which detract from its intrinsic strength, oxidation resistance and other properties.

A process has been developed at Chemetal which is generically similar to CVD. The microstructures of the resultant deposits are significantly different, however, in that the columnar grains which are typical of CVD materials are replaced by non-columnar deposits averaging 500-1000Å in grain size. This process has been referred to as Controlled Nucleation Thermochemical Deposition (CNTD).

The primary goal of the present program has been to achieve a better understanding of the CNTD mechanism as applied to SiC*. It has been assumed that the most desirable structure for a brittle ceramic such as silicon carbide would be that which has minimum flaw size, minimum flaw population, and minimum grain size. Thus, the emphasis during the present project has been on measuring room temperature flexure strength and the effects of various deposition parameters on it. Other characterization data obtained are hardness, fracture toughness (by indentation), surfact topography and microstructure, and chemical composition (by energy dispersive x-ray analysis).

^{*}The effort has spanned roughly 1-3/4 years. The present report covers the entire period although a summary report (1) was issued following the initial nine month period.

II EXPERIMENTAL EQUIPMENT AND PROCEDURE

During the Phase I (9 mos.) experiments deposits were made on tungsten wires directly heated by passing a current through them. In the second phase a hot wall graphite furnace was used to heat graphite bend bar substrates by radiation. Deposition parameters investigated included partial pressures of reactant species, total gas pressure, substrate temperature, gas preheat temperature, and various sources for silicon and carbon.

II. EXPERIMENTAL EQUIPMENT AND PROCEDURE

The experimental system used in the first phase of this work is schematically depicted in Figure 1. The main deposition chamber was an air-cooled 75mm diameter quartz chamber. The majority of the tests used two 0.05cm diameter x 20.32cm long resistively heated tungsten wires as substrates. Preliminary tests were run also, using 2.54cm diameter x 15.24cm long graphite tubes heated by induction. Argon, hydrogen, silicon and carbon bearing gases were introduced through an injector at the top of the chamber. A clamshell heater was used to regulate the pre-heat temperature of the reactant stream. The temperature in the reactant stream was monitored by placing a thermocouple 1.27cm from the filament and filament temperature was measured with a micro-optical pyrometer.

Methyltrichlorosilane (MTS)* was selected as the source of both carbon and silicon for the initial portion of the program. A gas metering system was used for MTS in which argon was used as a carrier gas. The carrier gas was passed through a vessel containing MTS, the amount of MTS carried being dependent upon the vapor pressure of the liquid.

*Properties of gases used are given in Appendix A.

Subsequently, the mixed stream was monitored through the use of a Hastings electronic mass flowmeter, and the flow of methyltrichlorosilane determined by measuring the difference between the flow of MTS with argon and the flow of argon alone. A similar system was used for silicon tetrachloride as the silicon source. In this case, the carbon source chosen was propane, which was dispensed as were the other gases through standard borosilicate glass rotameters with pressure gauges and needle type valves for maintaining constant metering pressure. The selection of deposition run time was made by choosing deposition rates and times to result in deposits of 0.05 to 0.065cm.

All deposits were characterized as to surface morphology, deposition rate, hardness and flexural strength. Modulus of rupture was determined by using a three point bend test. X-ray diffraction was used for phase identification, and energy dispersive analysis was used to determine the composition of the deposit. Fracture surfaces, as well as polished and etched surfaces, were examined metallographically with scanning electron microscopy to determine resultant microstructures. Several etching solutions were attempted with the most satisfactory results obtained by etching electrolytically using a solution of 5% chromic acid with 10cc HF in 100cc of solution.

Figure 2 illustrates the hot wall furnace system utilized during the Phase II (12 months) experiments. The furnace (an inductively heated graphite tube) was used to heat graphite bend bar substrates (2.54mm x 5.08mm x 76.20mm) and graphite cylinders (25mm diameter x 25mm long) from which

ring and disc samples could be cut after deposition. As in the wire experiments, a clam shell heater was used to control the preheat temperature of the gas stream. The graphite furnace temperature was monitored with an optical, disappearing filament, pyrometer.

In addition to the indirectly heated bend bar substrates, some runs were carried out on directly heated (by induction) graphite substrates 2.54cm diameter x 7.62cm long. The objective was to obtain 2.54cm diameter rings for burst tests. These results will be described below.

Argon was used as a carrier gas in conjunction with the various silicon bearing gases during the second phase experiments. Argon was passed through a boiler containing the silicon bearing liquid. The amount of liquid used was thus dependent on its vapor pressure, (i.e. the temperature in the boiler). The mass flow rates of reactants were obtained by means of standard borosilicate glass rotameters which were in turn calibrated against a Hastings electronic mass flowmeter.

Silicon bearing gases used were SiCl₄, SiHCl₃, and methyltrichlorosilane (MTS). Propane was the carbon source as required. Deposit thickness was roughly determined by deposition time and rate.

During the course of the second phase, more than 100 experimental runs were made. The deposits were characterized as to surface morphology, hardness, fracture toughness (by indentation), flexural strength (in three point bending), or burst strength (in the case of rings). Chemical composition was assessed using energy dispersive x-ray analysis. X-ray

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diffraction and scanning electron microscopy were used to examine as deposited surfaces, polished and etched surfaces and fracture surfaces.

Specific equipment and procedures used were as follows:

- 1. X-ray Diffraction A General Electric x-ray diffractometer was used incorporating C_UK_{α} radiation with a Ni filter, a time constant of 2, and an intensity range (full scale) of 2000 cps. All peaks obtained matched the ASTM diffraction data file for β -SiC, however, intensities varied considerably over the course of the experiments. See Figure 3 for a typical x-ray diffractometer scan.
- 2. <u>Scanning Electron Microscopy/EDS</u> Equipment available at the University of Southern California was used: a Cambridge Steroscan S4-10 coupled with a Tracor Northern energy dispersive x-ray spectrometer.
- 3. Transverse Flexural Strength Room temperature flexural strength measurements were carried out on a Comten testing machine. Both 3 point and 4 point fixtures were available. Three point measurements were emphasized in the first phase experiments using tungsten wire substrates (span 14.3mm). Specimens were approximately 1.8mm diameter x 40mm long; the wire diameter used was 0.5mm. Four point measurements were made on the graphite bend bar specimens used in the second phase (furnace) experiments. Coating thicknesses varied from 0.076mm to 0.50mm, span lengths were 1.90cm (inner) x 4.45 cm (outer).

III EXPERIMENTAL RESULTS AND DISCUSSIONS

- 4. Microhardness HV 500 were determined using a Leitz microhardness tester. Most values were in the range of 2500 to 3200 Kg/mm², but isolated values up to 4000 Kg/mm were noted. A magnification of 400X was used. No attempts were made to correlate hardness with microstructure. It is assumed that the fine grained, CNTD type microstructure is capable of some variation in hardness and that impurity effects may be present as well.
- from microhardness indent fracture characteristics using the Leitz microhardness tester (2). Some values apparently higher than 10 MPa/m were obtained but could not be verified by an outside laboratory. They were, however, repeatable in-house in measurements done 5 months after the initial work in-house. The question of fracture toughnesses greater than 10 MPa/m must be considered unresolved uncil the effect is verified and then investigated by means of a thorough series of experiments.

III. EXPERIMENTAL RESULTS AND DISCUSSION

The majority of investigations during the first phase of this study were conducted by depsoiting SiC on tungsten wires. The primary objective of this phase was to establish a set of operating parameters for reproducible manufacture of CNTD SiC. Subsequent investigations in the second phase were directed toward possible improvement from these baseline conditions and determining the sensitivity of the resultant deposit to variation in these parameters. It was determined that suitable conditions for CNTD SiC were:

total pressure

200-300 Torr

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substrate temperature	1100-1150°C
MTS	250 m1/min
hydrogen	3360 ml/min
argon	800 ml/min
gas preheat temperature	540° - 640°C

Processed according to these conditions, CNTD silicon carbide was deposited at a rate of approximately 0.26 to 0.38mm an hour. A typical resultant deposit was near stoichiometric, having a composition, containing a slight excess of silicon, approximately SiC_{0.95}. The deposits were found to be free of the columnar crystal habit indigenous to most CVD products, and had an average crystallite size in the range of 500-1000Å. The surface topography was unusual, as compared with conventional CVD products in that it was quite smooth with a typical surface roughness of 2-5 RMS. At low magnification, the material appears quasi-vitreous. Higher magnification of metallographic sections reveals a laminar structure not unlike that characteristic of pyrolitic graphite. X-ray diffraction revealed a consistent preferance for a (111) type texture in most of the deposits an example of which is shown in Figure 3. This effect may be explained by postulating that the SiC crystallites are deposited with (111) planes in the plane of the deposit, i.e. the growth direction is [111]. This growth is then interrupted repeatedly on a submicron scale; successive deposited material is not layed down randomly but retains its (111) texture. Transverse flexure strength values at room temperature as measured on a 3 point bend test, have been recorded in excess of 3100 MPa (464,000 psi). The Vickers Hardness of such material is typically 3600-4000 kpa as measured with a 500 gram weight. Critical stress

intensity factors (K_{1c}), representative of fracture toughness as measured by indentation methods, are 5 to 6 MPa $\frac{1}{m}$ in the growth direction and 4-5 MPa $\frac{1}{m}$ normal to the growth direction. Consult Table 1 for representative data.

In the course of Phase 1 investigations, the following effects were observed while trying to define CNTD conditions:

- 1. At a constant mixture ratio of hydrogen to methyltrichlorosilane

 (approximately 13:1) only columnar deposits were produced at filament
 temperatures above 1250°C without regard to total pressure.
- At these mixture ratios, deposits made below 200 torr were columnar without regard to filament temperature.
- 3. Noncolumnar deposits were made at filament temperatures in the range of $1100-1150^{\circ}$ C at total pressures between 200-300 torr.
- 4. The nature of the deposit was not responsive to variation in the mixture ratio of hydrogen to MTS.
- 5. Lower deposition temperatures tended to promote the deposition of excess silicon and higher temperatures, the deposition of excess carbon.
- All deposits were the cubic beta form of silicon carbide.

Having observed that deposition in the range of 1100-1500°C produced the desired structure, but that deposits tended to contain excess silicon, a slight modification in the system was introduced. A second active gas containing carbon was added. Propane proved to be a suitable additive. The addition of propane improved the stoichiometry, and in so doing appeared to improve the burst strength characteristics. Consult Table II Phase I Experiments for representative data.

Efforts were also conducted to produce deposits having similar characteristics to those obtained with MTS by using silicon tetrachloride as a silicon source and propane as a carbon source. These deposits, without exception, showed lower strengths and greater propensity toward a columnar crystal habit. The difficulties encountered during brief experiments with the silicon tetrachloride hydrocarbon system in Phase I were overcome during Phase II experiments.

Preliminary investigations were conducted on different substrates and shapes, to wit SX4 graphite tubes*, 2.54cm diameter x 15.24cm long. The SX4 graphite was selected owing to the fact that its coefficient of thermal expansion matches that of silicon carbide quite closely. Using essentially similar conditions to those used for the filament tests, fine grain non-columnar deposits of silicon carbide were achieved. Methyltrichlorosilane was employed as the silicon source with additions of propane to the gas stream to effect proper stoichiometry. Considerable difficulty was experienced, however, in maintaining uniform microstructure over the full 15.24cm length. This is attributed primarily to the buildup of the

^{*} Airco, Speer, St. Marys, Pennsylvania

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boundary layer on the surface of the part, which in turn, affects the pre-heat temperature of the gases and causes variation in the intermediate reaction products. Burst tests on rings formed during these experiments were unsatisfactory because of difficulty experienced in specimen preparation; values of 200 to 500 MPa (29-72.5 ksi) tensile strength were recorded. Failure always occurred from notches produced in cut-off so that intrinsic strength was never accurately measured. Data given in Table II.

In Phase II experiments rings cut from similar bars as just described were chamfered on the O.D. and oxidized for 2 hours at 900°C. Burst strengths after this procedure were 450 to 620 MPa (65 to 90 ksi). Strength values were quite consistent within each run using this ring preparation technique, the range of values being typically ± 10% from the mean. Refer to Table II, Phase II, Experiments for a compilation of these data.

By far the most influential factor noted in the course of the investigations was the regulation of pre-heat temperature, particularly as it related to resultant microstructure and flexural strength of the deposit. For filament temperatures of approximately 1125°C, the best pre-heat temperature of the gas appeared to be 575°C, or a difference between the pre-heat temperature and filament temperature of about 550°C, as measured approximately 1cm from the deposition surface. Initial indications were that at higher substrate temperatures a larger difference than 550°C is required to maintain strength, whereas at lower filament temperatures, a smaller difference in temperature is indicated.

Figures 4.5 and 6 compare CNTD material and columnar material which is typical of high quality conventional CVD silicon carbide. The significant difference in the fracture surfaces is interesting and warrants further study. From metallographic sections, there is clearly evidence of a laminar structure in the CNTD material as depicted in Figures 7, 8 and 9. Figure 7 shows distinct bands, and is representative of specimens of lower flexural strength (< 700 MPa). In Figure 8, the bands are finer with some variation. These specimens demonstrate flexural strength in the range of 700-2000 MPa. The most finely banded structures, as shown in Figure 9, evidence the best strength. Further investigations are being conducted to identify the morphology of the banding. It is believed to be related to the gas temperature and the kinetics of the reaction. The presumption can be made, although not yet proved, that the material structure as shown in Figure 7 may be caused by the presence of excess silicon. There is some concern that such a banded structure may contain considerable internal stress. No specific investigations of this possibility have as yet been conducted.

Experiments conducted by the CNTD process in the deposition of other materials have justified the conclusion that there is a basic difference between the mechanism of this process and that of conventional CVD (8). It has been hypothesized that an intermediate compound is actually deposited on the substrate and is subsequently thermochemically converted to the final product. The thermochemistry of the deposition of silicon carbide has been considered in light of this hypothesis.

Evidence of a lower chloride of silicon having a composition of SiCl_{2,6} has been claimed (3). In fact, in the course of the subject investigations, such a material has been observed as an extremely low vapor pressure amber liquid (See Fig.15). To justify its existence as a liquid at elevated temperatures (circa 1000°C) under the pressure conditions in the reaction chamber, it must be postulated that the material is polymeric. Free energy data are not available for (SiCl_{2,6})_X, but it is believed by Chemetal to be an important intermediate product in the CNTD of silicon carbide. Such an assumption seems consistent with the experimental observations. When the deposition temperature is raised or the total pressure reduced, the CNTD product is not made. This is probably because these conditions tend to distill the intermediate and prevent its collection on the substrate.

The effect of the gas pre-heat temperature and the difference between MTS and silicon tetrachloride as silicon sources may also be considered in light of the postulated deposition mechanism of an intermediate product. Compare the following reactions:

 $CH_3SiCl_3 \rightarrow SiCl_3 + C + 3/2 H_2$

 $\Delta G_{800}o_{K} = -2.950 \text{ kcal}$

 $CH_3SiCl_3 \rightarrow SiC + 3 HCL$

 $\Delta G_{8000}_{K} = -0.84 \text{ kcal}$

SiC14 + CH4 + SiC13 + CH3C1 + 12 H2

 $\Delta G_{8000}_{K} = + 38.935 \text{ kcal}$

The free energy data used is from the JANAF Tables (4). This comparison

is made using $SiCl_3$ as the product since no free energy data are available for $(SiCl_{2.6})_X$.

It may be concluded that silicon trichloride is made more readily from MTS than it is from a mixture of silicon tetrachloride and a hydrocarbon at 800°K. Similarly, there is a slightly higher potential for the formation of silicon trichloride from MTS than there is for the formation of silicon carbide.

These data suggest that a pre-heat temperature of 800°K might be significant in the formation of the necessary intermediate deposit. The data also suggest that conditions for making a CNTD deposit from the silicon tetrachloride/hydrocarbon system would have to be substantially different from those used for the MTS system.

The main objective of the first phase was thus accomplished. A set of deposition parameters was determined which produced very high room temperature flexure strengths of deposits on tungsten wires. Modest exploration of parameter changes were made in anticipation of Phase 2 experiments.

It should be noted that during the time of the first phase work, samples of CNTD SiC deposited on tungsten wires were furnished to NASA (Lewis)

Research Center for verification of their properties. Specimens from that batch in turn were given to Naval Research Lab. and to the Air Force

Materials Laboratory for other property measurements. Chemetal room temperature flexure strengths were verified. In addition, elevated

temperature strengths showed unexpected behavior in that they were higher at 1300°C than at room temperature⁽⁵⁾. This result may be rationalized by postulating a residual tensile stress present at room temperature which is relieved at temperatures near the deposition temperature⁽⁶⁾. Room temperature flexure strengths (four point bending) were 1724 MPa (250,000 psi) while strengths measured at 1300°C in nitrogen varied widely but averaged approximately 2759 MPa (400,000 psi). These values generally confirm Chemetal in-house results at room temperature.

Second phase experiments began with explorations of different Si bearing gases in an attempt to generalize the conditions evolved in the first phase (9 month) study for CNTD SiC. Essentially the same experimental setup as in the first phase was used (Fig. 1) for directly heated tungsten wires. See Table III for typical deposition conditions and Figures 10, 11 and 12 for graphical representation of the trends.

It was desired to explore alternative Si bearing gas systems. Therefore experiments were conducted using $SiCl_4/H_2/$ propane (24 runs) and $SiHCl_3/H_2/$ propane (5 runs). The results of these investigations may be summarized as follows:

- The CNTD structure was observed throughout the experiments using SiCl₄ and SiNCL₃.
- The SiHCl₃ system yielded much higher deposition rates than did the SiCL₄ system, up to 2X the rates under similar temperatures and pressures.

- 3. The most important parameter affecting the deposition rate in the SiCl₄ system was chamber pressure. Fig. 10 gives the combined effect of chamber pressure and part temperature for this system.
- 4. The effects of substrate temperature on strength and deposition rate are shown in Figures 10, 11 and 12.
- 5. In general, the CNTD structure was attained when:
 - a) The substrate temperature was ($\leq 1150^{\circ}$ C), hydrogen flow was ($\geq 4000 \, \text{cm}^{\,3}/\text{min}$), gas stream temperature was ($\geq 675^{\circ}$ C), and chamber pressure was between 250 and 500 Torr.
 - b) The substrate temperature was ($\gtrsim 1150^{\circ}$ C) hydrogen flow was ($\le 500 \, \text{cm}^{3}/\text{min}$), the gas stream temperature was ($\le 570^{\circ}$ C), and chamber pressure $\gtrsim 500 \, \text{Torr}$.

After the initial explorations of various Si source gases, Phase II experiments continued with attempts to transfer CNTD technology from deposition on directly heated wires to deposition on substrates heated in a furnace. Attempts were made to use the SiCl₄/H₂/ propane system for initial furnace runs, but delamination and microcracking of the deposits and time constraints necessitated return to the MTS system. The reaction chamber was shown in Figure 2. Substrates were graphite (UT22, Ultracarbon Co.) bend bars having dimensions 76mm x 3.17mmx 6.35mm.

SiC deposits were made in an initial series of experiments which explored the effect of substrate temperature and the position of the substrate in the furnace chamber in an attempt to get uniform deposition over the 76mm length of the substrate. Substrate temperature varied from 1100° C to 1230° C as determined by an optical pyrometer sighting on the part in the furnace.

Deposits made at substrate temperatures between 1100° and 1150° C were mechanically weak. Better results were achieved between 1200° C and 1250° C, where the fracture toughness was observed to increase from values of 4 to 6 MPa $\frac{1}{100}$ (at 1100° C to 1150° C) to 15 to 16 MPa $\frac{1}{100}$. X-ray dispersive analysis of these samples showed the presence of chlorine which seemed to be associated with the increased fracture toughnesses.

The presence of measurable amounts of chlorine could be explained by postulating the presence of a polymeric liquid phase (e.g. SiCl_{2.6}) as described above which was not being completely reacted during the deposition process. Attempts were made to reduce or eliminate the chlorine content by increasing the hydrogen fraction in the gas stream. These experiments were successful in obtaining stoichiometric or silicon excess deposits but the fracture toughness returned to the range of 5 to 7 MPa m. It became clear that the high fracture toughnesses were associated with silicon deficiency, and chlorine contents of 0.2 to 2 wt/%.

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Some elementary heat treatment experiments were carried out on selected samples in which the high fracture toughnesses had been observed. Data for these experiments is given in Table V. The purpose of these experiments was to obtain some data on the stability of the effect. Accordingly samples for which the fracture toughness and chlorine contents had been measured were heat treated at furnace temperatures of 1400° or 1550° C in flowing argon for times which varied from 1 hour to 3 hours. It can be seen from the data that hardnesses generally decreased after heat treatment, although high fracture toughnesses were still associated with chlorine contents between 0.2 and 2.0% by weight with an apparent maximum at about $1^{\text{wt}}/\text{o}$. Silicon contents for all high fracture toughness samples both before and after heat treatment were substoichiometric.

Time and program constraints prevented any other investigations of the anomalously high fracture toughness effects.

Fig. 13 shows the surface and interior structure of the SiC layer of sample (run) #751, for which pertinent data are given on Table: IV. The lack of visible microstructure until one reaches a magnification of 20,000% is apparent. The graphite substrate is visible in the split field bottom picture.

During the course of these studies, CNTD SiC was deposited on NC203 (hot pressed SiC, Norton Co.) flexure test bars to explore its effect on strength of the bars. Fig. 14 shows one of these deposits. The NC203

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substrate is visible in the upper left view. The upper right view shows the structure at 20,000X. The bottom view shows a Vickers hardness indent made under a load of 2000 gms in attempt to compute a fracture toughness. The apparent hardness using this indent is HV_{2000} = 3860 kg/mm². A 2000 gm indent at another location showed cracks from which a fracture toughness of 15.7 MPa m was calculated. The strength of the NC203 bars was raised from approximately 668 MPa (100,000 psi) to 828 MPa (120,000 psi) by adding the 0.015cm (0.006 in) CNTD SiC coating (7).

At the end of the experimental program, CNTD SiC was deposited on 2.54cm D. x 2.54cm long graphite substrates in a furnace using a range of deposition conditions as shown in Table VI. Six discs were cut 0.6cm from the top coated surface of these substrates; a-1 discs had a SiC layer of 0.51 to 0.65mm (0.020 to 0.025 in) on them. The discs were furnished to the Contract Technical Monitor for further evaluation.

IV CONCLUSIONS AND RECOMMENDATIONS FOR FURTHER WORK

IV CONCLUSIONS AND RECOMMENDATIONS FOR FURTHER WORK

- 1. CNTD silicon carbide having unusual strength and hardness characteristics can be made from active gas mixtures of:
 - a) methyltrichlorosilane/hydrogen
 - b) silicon tetrachloride/hydrogen/propane
 - c) trichlorosilane/hydrogen/propane
- 2. Proper control of deposition parameters such as substrate temperature, gas temperature, chamber pressure is important.
- 3. There is an apparent intermediate product formed, probably existing as a polymer of a lower chloride of silicon, which is an important precursor in the CNTD SiC process.
- 4. The presence of unexpected high fracture toughness values associated chlorine contents of 0.2 to 2.0 wt/o was observed.
- 5. Deposition of CNTD SiC on flexure test bars in a furnace has been demonstrated as a first step in scale up, but further work remains to extend scale up activities to larger and more complex geometries.
- 6. As scale up activities proceed and it is apparent that CNTD SiC is a candidate for high temperature structural applications, its elevated temperature mechanical properties (strength, creep, stress rupture, internal stresses) should be characterized.

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7. Initial evidence for the existence of a SiC material having significantly higher fracture toughness than any bulk processed SiC has been obtained. This material, the conditions under which it is formed and its other properties should be characterized in a separate study. REFERENCES

V

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REFERENCES

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VI APPENDICES

- A Properties of gases
- B Calculation of Flexural Strength of a Rectangular Graphite Bend Bar

Page 22 APPENDIX A

PROPERTIES OF GASES USED IN SiC EXPERIMENTS

GAS	SUPPLIERS/GRADE/IDENTIFICATION	MINIMUM PURITY
argon	Union Carbide, Linde Div. Liquid phase	99.998%
hydrogen	Union Carbide, Linde Div. Prepurified Grade	99.99%
nitrogen	Union Carbide, Linde Div. Liquid phase	99.997%
ammonia	Union Carbide, Linde Div. Specialty Gas Products Group, Anyhdrous Grade	99.98%
propane	local Southern California dealers heating quality	96%
methyltri- chlorosilane	Union Carbide, Chemicals and Plastics Div. A-154	98.5%
trichloro- silane	Union Carbide Chemicals and Plastics Div., A-19	99.9%
silicon- tetrachloride	Air Products and Chemicals, Inc., Specialty Gas Dept., Semi-Conductor Grade	99.7%

APPENDIX B

Calculation of Flexural Strength of a Rectangular Graphite Bend Bar

Consider a composite beam of two materials A and B of different elastic moduli such that B forms a uniform coating around A. When this beam is subjected to flexure, the calculation of the flexure strength may be simplified by the method of equivalent section. By this method, the cross section of the substrate can be replaced by an equivalent section of the deposit such that at a given magnitude of axial strain, the force developed in the substrate and the equivalent section of the deposit are equal. Then the entire section can be treated as a single homogeneous material. It is assumed in this procedure that no slip occurs at the interface. The equivalent section is generated by changing the dimension of the substrate in the direction perpendicular to the direction of applied load.

For a given axial strain e, the force developed on the substrate is $F_s = eE_sA_s$, and that in the coating at the same point is $F_c = eE_cA_c$. For $F_c = F_s$, we have $E_cA_c = E_sA_s = nE_cA_s$ where $n = E_s/E_c$. Thus the equivalent area of the coating is equal to nA_s .

1. Rectangular Graphite Bend Bar

Consider now a rectangular beam of cross-section b_1xh_1 as shown in Fig. 1. A coating thickness t is applied uniformly on this substrate, so that

$$\frac{b_2-b_1}{2} = \frac{b_2-b_1}{2} = t$$

The area of the coating is $A_c(=b_2h_2-b_1h_1)$ and that of the substrate is $A_s(=b_1h_1)$. In the transformation of the area of the substrate, the dimension b_1 is changed to $n.b_1$.

In the case of a deposit of SiC or Si_3N_4 on graphite, we have the following: $E_{graphite}^{\simeq}10$ GPa, $E_{SiC}^{\simeq}450$ GPa and $E_{Si_3N_4}^{\simeq}310$ GPa. Then, n=Es/Ec is equal to 0.022 and 0.032 for SiC and Si_3N_4 , respectively. Thus, the equivalent area of the coating is only 2 to 3 per cent of the original substrate area. For all practical purposes, the graphite substrate is replaced by a void space. Then, the rectangular composite beam may be treated as a hollow beam.

For the purpose of calculating the moment of inertia, the hollow rectangular section is equivalent to an "I" section, as shown in Fig. 2. Thus,

and
$$\sigma_{max} = \frac{6Ph_2 a}{b_2h_2^3 - b_1h_1^3}$$
 where, $a = length of moment arm$

2. Tungsten Wire Substrate

The coating of SiC on a tungsten wire substrate can also be analysed in a similar manner. For a circular section the transformation of the substrate leads to an elliptical equivalent section as shown in Fig. 3., where the minor axis is equal to $n.d_s$ and the major axis is d_s .

For a deposit of SiC on tungsten, the modulus ratio, n is 0.87 (E_w =390GPa). Thus, as a first approximation, n may be taken as unity and the entire deposit may be treated as a single, homogeneous material. On the other hand, if an exact solution is sought, the moment of inertia of the transformed section is calculated as follows:

Itotal = Itubular section + Ielliptical section

$$= \frac{\pi}{64} \left(\frac{d_c^4 - d_s^4}{64} \right) + \frac{n\pi d_s^4}{64} s^4$$

$$= \frac{\pi}{64} \left\{ d_c^{4} - (1-n) d_s^{4} \right\}$$

$$=\frac{\pi}{64}(d_c^4-0.13d_s^4)$$

Taking a typical example, $d_c=1.5 \,\mathrm{mm}$ and $d_s=0.5 \,\mathrm{mm}$ gives I= 0.2481 mm⁴ using the expression above, and I=0.2485 mm⁴ if n is taken as unity. It is clear, therefore, that in the case of SiC on tungsten, the entire section can be treated as a single homogeneous material for the purpose of calculating the flexural strength.

It should be pointed out that in these calculations, the effect of the interface on the stress distribution in the material under flexural loading is neglected.

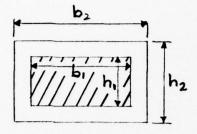
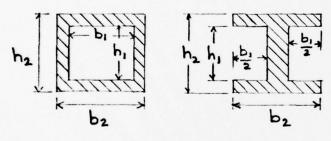


FIGURE 1



$$I = \frac{b_2 h_2^3 - b_1 h_1^3}{12}$$

FIGURE 2

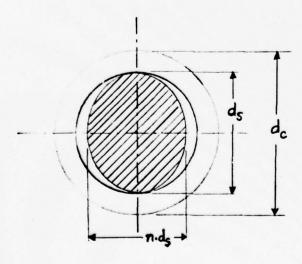
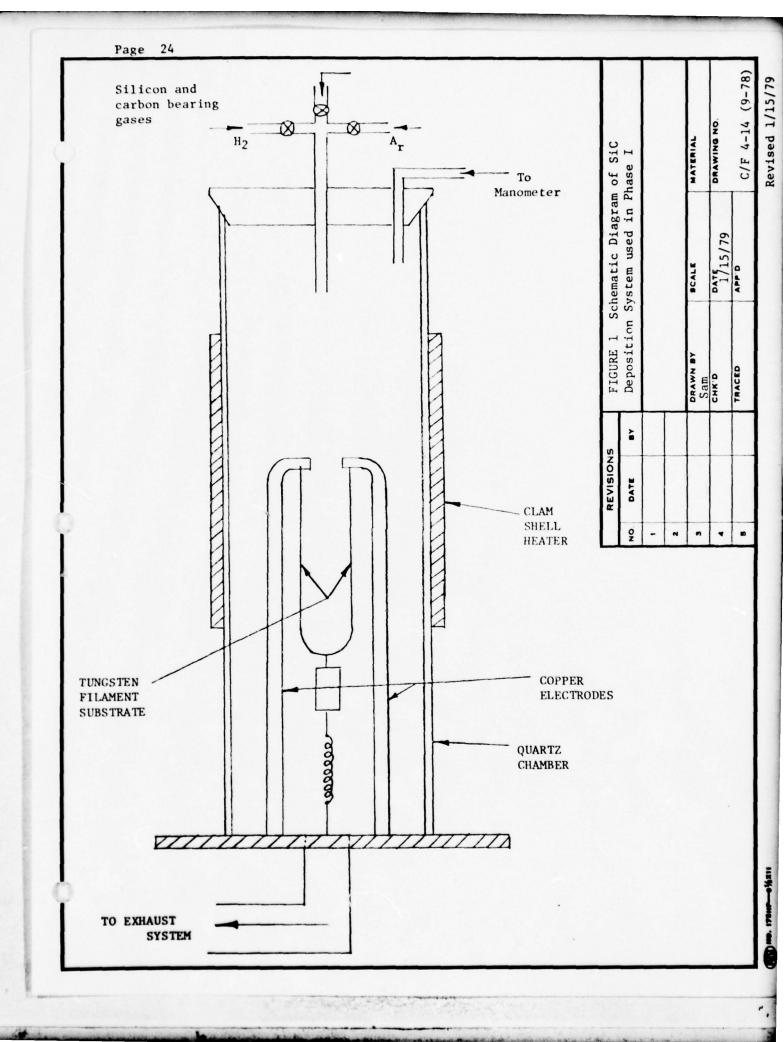


FIGURE 3
APPENDIX B

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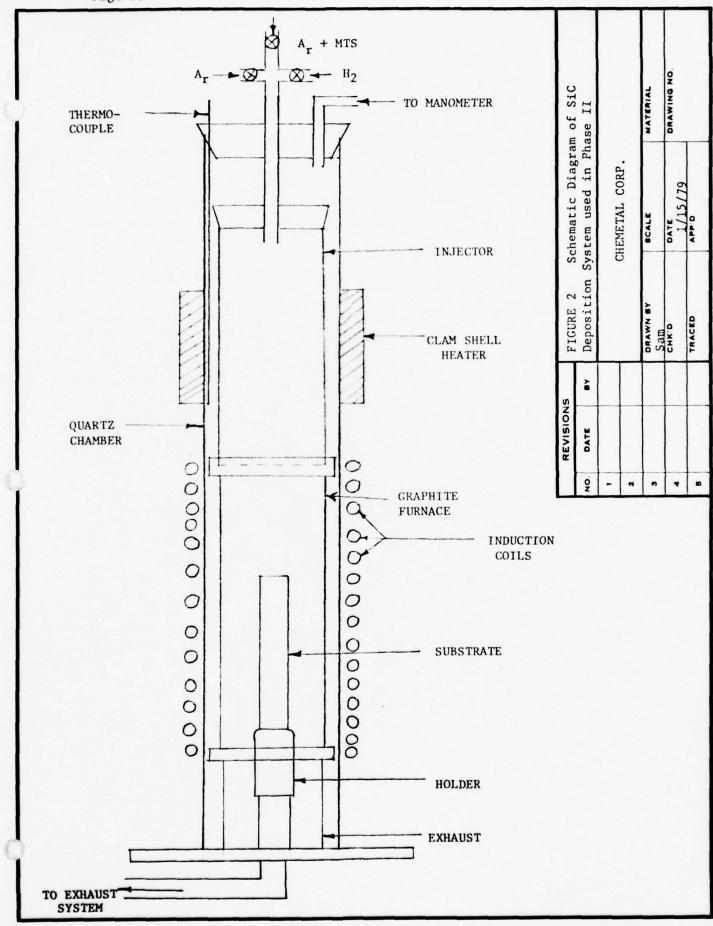




FIGURE 4

Fracture Specimen CVD SiC, 50X Magnification

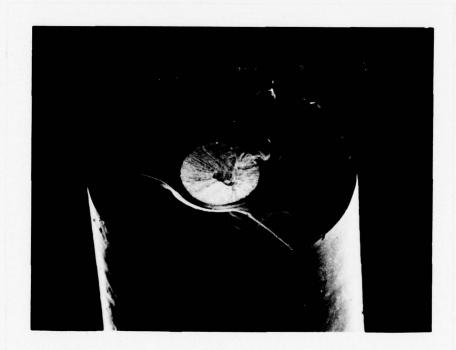


FIGURE 5

Fracture Specimen CNTD SiC, 50X Magnification

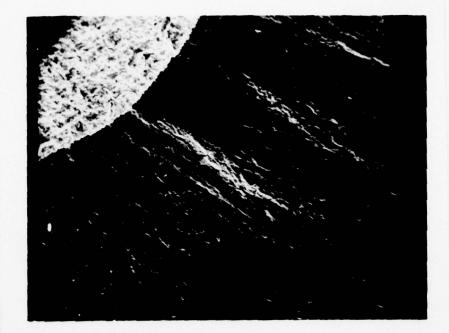


FIGURE 6

Section CVD SiC, 500X Magnification

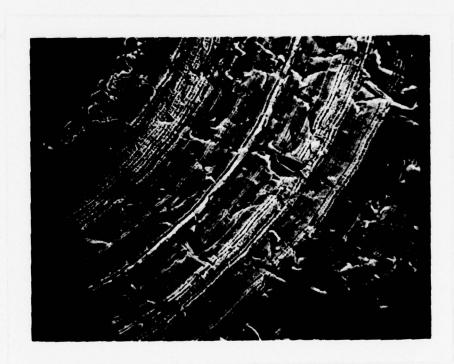


FIGURE 7

Section Low Strength CNTD SiC, 500X Magnification

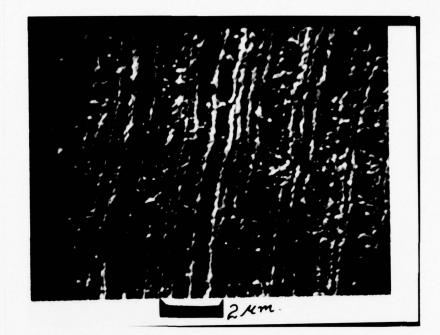


FIGURE 8

Section Medium Strength CNTD SiC

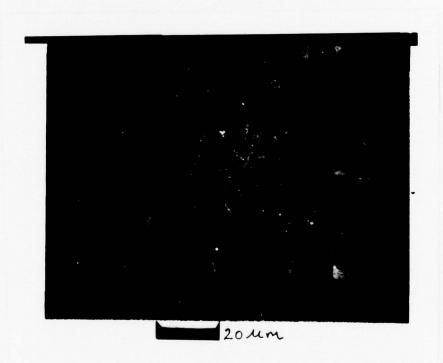


FIGURE 9

Section High Strength CNTD SiC

CHEMETAL CORP.

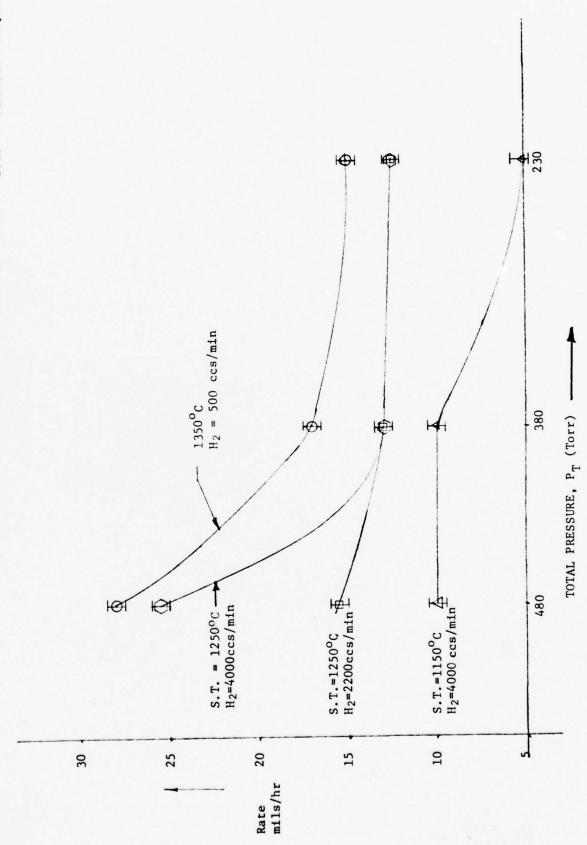
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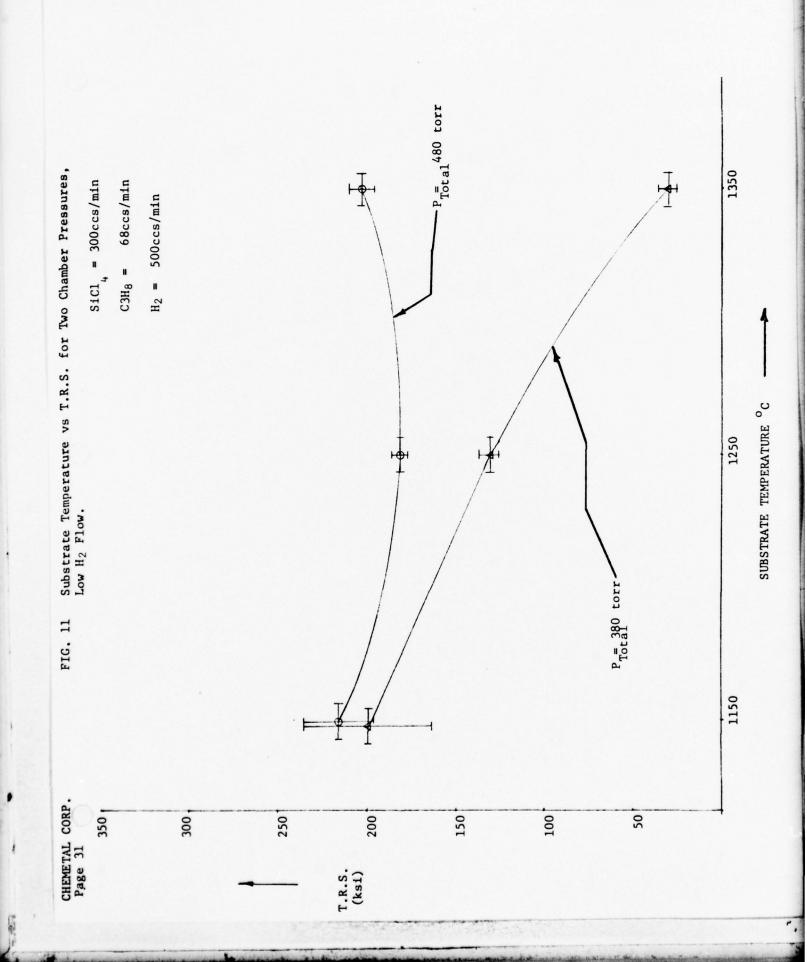
FIG. 10 Chamber Pressure vs. Deposition Rate for Various Hydrog. Flows and Substrate Temperatures.

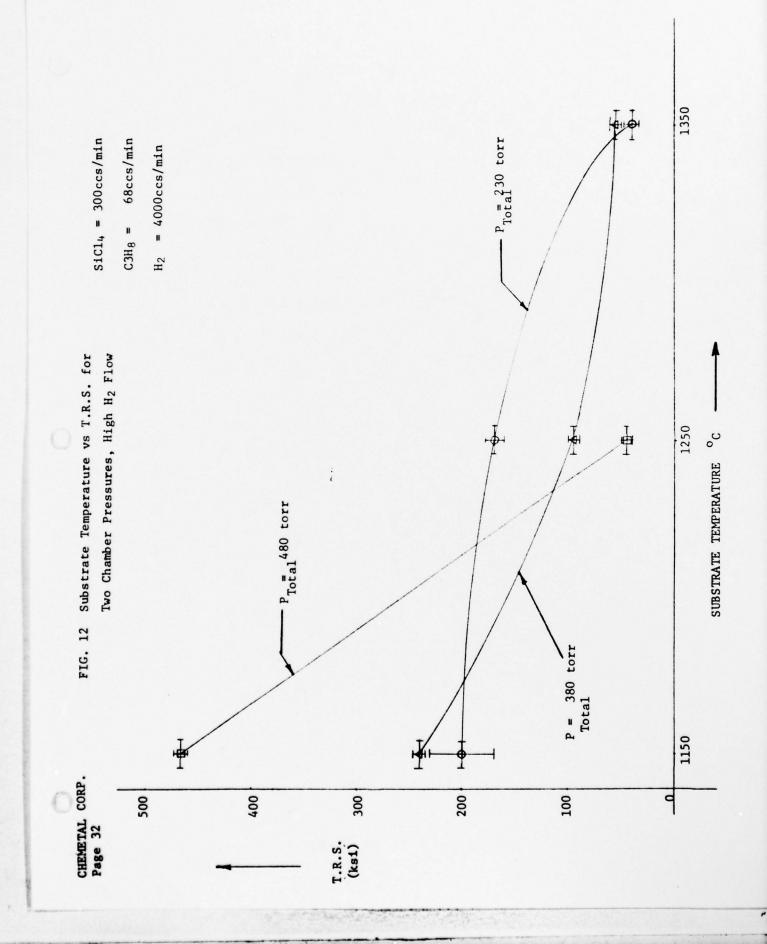
SiCl4 = 300ccs/min

 $C3H_8 = 68ccs/min$

S.T. = substrate temperature











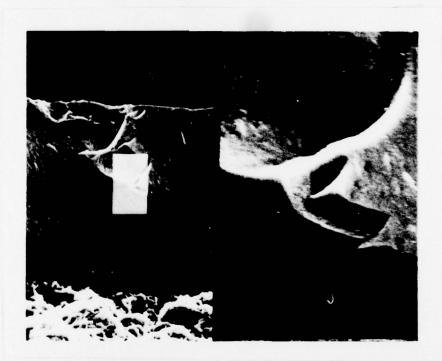


FIGURE 13 Sample (Rum) #751, High Fracture Toughness CNTD SiC Deposit on Graphite (See Table IV). Upper Left-surface, 100X; upper right-coating interior, 20,000X; bottom-split view-coating interior, 200X/1000X.



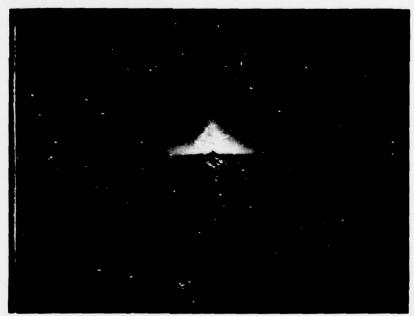


FIGURE 14

CNTD SiC Deposition on NC203 (Norton Co.) Hot Pressed SiC substrate. Upper left-coating section incl. substrate, 500X; upper right-interior of coating, 20,000X; bottom-Vickers indent. at 2000 gm load (no visible cracks), 1000X. A measurement at a different location gave 15.7 MPa m. HV 2000= 3860.

0



FIGURE 15 "Frozen Liquid" appearing material observed during deposition of SiC, 200X

VIII

TABLES

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TABLE I CNTD Silicon Carbide Depositio. Conditions and Results Phase I Experiments

Specimen	Pressure	Filament	Gas	Argon	Hydrogen	MTS	Additive	T.R.S.*
Number	(Torr)	Temp. C	Temp. °C	(cc/min)	(cc/min)	(cc/min)	(cc/min)	(MPa)
136	367	1120	•	1400	2700	230		1076
138	280	1110	1	096	2700	225	CH ₂ 70	1020
139	380	1110		096	2700	200		414
144	380	1130	•	096	3500	225		1083
148	380	1150	1	096	3500	200	,	1545
150	380	1150	1	096	3500	200		1558
154	380	1150	1	800	3500	200		1269
155	380	1150	1	850	3500	227		1269
158	405	1150	•	850	3500	230		841
161	380	1150	1	850	3500	225		75
176	127	1150	537	850	3360	250		09
180	127	1225	579	850	3360	250		65
182	127	1175	579	1160	3360	420		34
183	127	1175	579	1160	3360	420		834
184	127	1200	579	800	3360	420		65
186	253	1150	009∿	800	3360	250		1790
00.	000			000	0,00			
169	977	var.	23/	800	3300	007		1551
192	253	Var.	607	800	3360	250		903
193	253	1150	579	800	3360	250		5069
761	253	1150	565	800	3360	250		103%
195	253	1150	593	800	3360	250		3448
196	253	1170	593	800	3360	250		1676
197	253	1140	593	800	3360	250		2090
198	253	1140	909	800	3360	250		1690
199	253	1140	280	800	3360	250		1924
200	253	1120	580	008	3360	250		167.8
202	253	1120	593	800	3360	250		1379
203	253	1120	607	800	3360	250		2069
204	253	1120	624	800	3360	250		2414
*Transve	*Transverse Rupture	Strength,	3 pt. bending	n.				

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TABLE 1 -- Cont'd.

T.R.S. (MPa)	3448 2415 1724 1303	1710 1669 1103 1586 1200	1324
Additive (cc/min)		8	85
Add		C3 H8	S
MTS (cc/min)	250 250 250 250	250 250 250 250 350	350
Hydrogen (cc/min)	3360 3360 3360 3360	3360 3360 3360 3360 3100	3100
Argon (cc/min)	800 800 800 800	800 800 800 800 500	200
Gas Temp.°C	635 635 646 646	646 646 621 616 690	701
Filament Temp. ^o C	1120 1110 1100 1100	1100 1110 1115 1115 1200	1200
Pressure (Torr)	253 253 253 253	253 253 253 253 253	253
Specimen Number	205 206 207 209	210 212 214 215 224	226

Burst Test Specimen Dimensions: 0.064 cm wall thickness x 0.318 cm height x 2.54 cm I.D. Ring Burst Test Conditions and Results, Phase I and II Experiments TABLE II

PHASE I EXPERIMENTS

	269/39,000	332/48,200	300,43,500	389/56,400	414/60,000	
Burst Strength (MPa/psi)	269	333	300	386	41,	
Hydrogen Flow (cm ³ /min)	9059	6500	6500	6500	9059	
MTS to Propane Ratio	> 14.0	14.3	11.1	10.0	6.4	
Gas Temp.	426	426	426	426	426	
Substrate Temp. (°C)	1130	1130	1130	1130	1130	
Chambers Press. Substrate (Torr) Temp. (^O C)	253	253	253	253	153	

$0.0.0.0$ of that sample chamfered, sample heated in air at $900^{\circ}\mathrm{C}$ for 2 hours	448/65,000* 373/54,000*	345/50,000 435/63,000*	248/36,000*	793/115,000* 448/65,000*
sample heated in ai	373/54,000 379,55,000 530/77,000	455/66,000 124,18,000		545/79,000* 503/73,000*
chamfered,	6728	2400	4000	0009
D, of that sample	11.1	11.1	11.1	11.1
_	450	510	480	200
PHASE II EXPERIMENTS, (*) Indicates	1140	1120	1130	1130
PHASE II	254	240	240	254

483,70,000*

0009

11.1

465

1110

254

TABLE III DEPOSITION CONDITIONS ON WIRES, PHASE II EXPERIMENTS

Run#	Pressure Torr	Part T	Gas T	Argon (ccs/min)	SiCl ₄ (ccs/min)	C3Hg (ccs/min)	H ₂ (ccs/min)	T.R.S. (ks1)	Deposition Rate (mils/hr)
418	230	1150°C	1250°F	1500	300	89	4000	200	5
420	230	1250°C	1150°F	1500	300	89	4000	170	12.5
425	230	1350°C	1050°F	1500	300	89	4000	39.8	12.5
426	380	1150°C	1250°F	1000	300	89	4000	240	10.0
428	380	11500	1250°F	1000	300	89	200	200	7.0
429	380	1250°C	11500	1000	300	89	200	130	12.0
431	380	1250°C	1150°F	1000	300	89	4000	0.96	13.0
432	380	1350°C	1050°F	1000	300	89	200	31.0	17.0
434	380	13500	1050°F	1000	300	89	4000	53.0	21.0
436	780	1150°C	1250°F	1000	300	89	200	216.0	0.9
438	480	1150°C	1250°F	1000	300	89	4000	462.0	10.0
439	780	1250°C	1150°F	1000	300	89	200	181.0	13.0
441	480	1250°C	1150°F	1000	300	89	4000	48.0	26.0
442	780	1350°C	1050°F	1000	300	89	200	204.5	28.0

TABLE III 1 of 2 Pages

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TABLE III DEPOSITION CONDITIONS ON WIRES, PHASE II EXPERIMENTS

Run #	Pressure (Torr)	Part T	Gas. T	N ₂ (ccs/min)	$S1HCl_3*$ C_3H_8 H_2 (ccs/min) (ccs/min)	C _{3H8} (ccs/min)	H ₂ (ccs/min)	T.R.S. (ks1	Rate (mils/hr)
697	380	1250°C	1180°F	1100	275	89	2200	157	25
470	380	1250°C	1150°F	1100	275	89	1500	393 100	25
471	230	1250°C	1120°F	1100	275	89	1500	218	23
472	230	1150°C	1130°F	1100	275	89	1500	394	20
473	230	1350°C	1150°F	1100	275	89	200	101	29

*Note change in Si bearing species from SiCl₄ to SiHCl₃

Table III Page 2 of 2

Page 40-1

TABLE IV Deposition Conditions on Graph...e Bend Bars, Phase II Experiments

				to valve malfunction.		during run	*Flow Changed during run due	1 26 2	9000
67.7	0.2	6.9	3250	•	150	750	20	1240	757
58.8	0.9	no cracks at 2000gm	2900	630/91,400	100 to 350*	750	50	1235	756
53.8	2.2	microcracks No F.T.	2600	•	50	750	50	1235	755
56.4	1.8	500	3400	319,46,280	1	750	100	1240	754
53.1	1.6	7.67 2000 one indent-no cracks	2430 2455	347/50,350	1	750	25	1235	753
54.2	1.7	11.3) 8.8) 2000	31.30 25.70	641/92,890	ı	750	20	1235	752
56.2	1.2	13.2	3990	365/52,900		750	75	1235	751
67.9	00.0	4.7) 5.5) 500	3620 3100	•		750	125	1230	750
9.69	0.1	5.6) 5.6) 500	2930 3490	1		750	250	1225	149
68.6	0.3	4.4)	3320 2930			750	200	1225	748
71.4	0.1	6.5) 7.2) 300	3192 3250	1	ı	750	1000	1225	747
70.0	0.0	5.6) 5.5) 500	3130 3030	•	ı	750	2000	1210	746
70.6	0.4	5.2) 6.5) 500	3530 3490			750	3000	1230	745
wt/o S1	wt/o C1	Fracture Toughness (MPa 4m) load in gm-subscript	Vickers Hardness (kg/mm ²)	TRS 3 pt. Bend (MPa/ps1)	Sincl ₃ Flow (cm ³ /min)	MTS Flow (cm ³ /min)	Hydrogen Flow (cm ³ /min)	Substrate Temp(^C C)	Sample (Run)#

¹ of 2 ** Flow Changed during run

Deposition Conditions on Graphite Bend Bars, Phase II Experiments TABLE IV Page 40-11

wt/o S1	8.69	69.2	69.1	68.4	69.4	70.0	8.69	
wt/o C1	0.1	00.0	00.00	00.00	0.00	00.0	00.0	
Fracture Toughness (MPa vm) load in gm-subscript wt/o Cl wt/a Si	5.0	7.3 500	6.2	8.3	5.9	3.9	5.3	
Vickers Hardness (kg/mm ²)	35 80	3425	3320	3100	3320	3305	3130	
TRS 3 pt. Bend (MPa/ps1)	•	•	•	•	475/68,870	•	-	
S Sincl ₃ Flow in) (cm ³ /min)	25	350	350	200	200	700	250	
MTS Flow (cm ³ /min)	750	200	200	200	200	200	200	
Hydrogen Flow (cm ³ /min)	27	400	750	50	50	50	25	
Substrate Temp(°C)	1240	1240	1230	1240	1180	1170	0711	
Sample (Rum)*	758	761	762	763	764	765	766	

RUN	H.T.*	H.T.	C1%	C1%	S1%	S1%	Hardness + Hardnesst V.H.N. V.H.N.	+Hardnes V.H.N.	sst F.T.##	F.T.
NO.	TEMP.	TIME	B.H.T.#	A.H.T.**	B.H.T.	A.H.T.	B.H.T.	A.H.T.	. B.H.T.	A.H.T.
753	1550°C 3 hrs	3 hrs	1.6%	1.5%	53.1%	26.5%	2442	2070	7.67 one	16.4 two
									m	no cracks
756	1550°C	3 hrs	26.0	0.7%	58.8%	59.1%	2960	1735	no F.T.*** 9.65	9.65
745	1550°C	1 Hr	27.0	0.01%	70.6%	70.0%	3510	2800	5.8	4.4
755	1400°C	2½ hrs	2.2%	1.8%	53.8%	57.1%	2600	2910	Very brittle No F.T. possible	8.2
969	1400°C	1 hr	2.13%	2.1%	52.7%	51.4%	2900	2570	15.0	6.9
757	1400°C	1 hr	0.2%	76.0	67.7%	65.4%	3250	3060	4.9	7.25

* H.T. = Heat Treatment

B.H.T. = Before Heat Treatment

**A.H.T. = After Heat Treatment

F.T. = Fracture toughness MPa 📶

*** F.T. = No cracked indents observed in this sample therefore, No F.T. could be calculated.

= All hardness values kg/mm² using 500 gm load

TABLE VI

CNTD SiC DISCS, 2.54 cm Diameter

	The second secon							
	Pressure			Argon	MTS*	$^{ m H_2}$	Thickness	Vickers Hardness**
Run#	(torr)	Part T	Gas T	(cc/min)	(cc/min)	(cc/min)	(mils)	(kg/mm ²)
797	280	1200°C	875°F	1000	750	100	~ 20- 25	3525
798	254	1200°C	860°F	1000	750	1000	· 20- 25	3360
799	260	1200°C	875°F	1000	200	100	~ 25	2895
803	272	1200°C	1190°F	2000	200	1	· 20- 25	2270
803	267	1200°C	1190°F	2000	200	1	~ 20- 25	2150
804	267	1210°C	1255°F	2750	200	1	~ 20 - 25	2995

*MTS: Methyltrichlorosilane

500 gm load